



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = 25°C
	$30m\Omega$ @ $V_{GS} = 10V$	13.8A
40V	54mΩ @ V _{GS} = 4.5V	10.3A

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- DC-DC Converters
- Power management functions

Features and Benefits

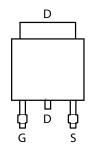
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

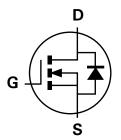
- Case: TO252-3L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.33 grams (approximate)



Top View



Top View Pin-Out



Equivalent Circuit

Ordering Information (Note 3)

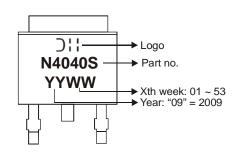
Ī	Part Number	Case	Packaging
	DMN4040SK3-13	TO252-3L	2500 / Tape & Reel

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information

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Maximum Ratings @T_A = 25°C unless otherwise specified

Character	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	40	V		
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Drain Current (Note 4) V _{GS} = 10V	Steady State	T _A = 25°C T _A = 70°C	I _D	6.0 4.8	А
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	T _A = 25°C T _A = 70°C	I _D	9.3 7.4	А
Continuous Drain Current (Note 5) V _{GS} = 10V	t ≤ 10s	T _A = 25°C T _A = 70°C	I _D	13.8 11.0	А
Continuous Drain Current (Note 5) V _{GS} = 4.5V	Steady State	T _A = 25°C T _A = 70°C	I _D	6.9 5.5	А
Continuous Drain Current (Note 5) V _{GS} = 4.5V	t ≤ 10s	T _A = 25°C T _A = 70°C	I _D	10.3 8.2	А
Pulsed Drain Current (Note 6)	I _{DM}	50	А		

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Power Dissipation (Note 4)	P _D	1.71	W
Thermal Resistance, Junction to Ambient @T _A = 25°C (Note 4)	$R_{ heta JA}$	72.9	°C/W
Power Dissipation (Note 5)	P _D	4.1	W
Thermal Resistance, Junction to Ambient @T _A = 25°C (Note 5)	R _{0JA}	30.8	°C/W
Power Dissipation (Note 5) t ≤ 10s	P _D	8.9	W
Thermal Resistance, Junction to Ambient $@T_A = 25^{\circ}C$ (Note 5) $t \le 10s$	$R_{\theta JA}$	14	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics @ T_A = 25°C unless otherwise stated

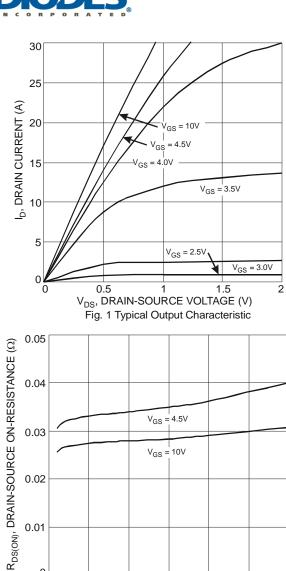
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	-	-	1.0	μΑ	$V_{DS} = 40V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	$V_{GS(th)}$	1.8	2.3	3.0	٧	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance		-	20	30	mΩ	$V_{GS} = 10V, I_D = 12A$	
Static Drain-Source On-Resistance	R _{DS} (ON)	-	43	54	11122	$V_{GS} = 4.5V, I_D = 6A$	
Forward Transfer Admittance	Y _{fs}	-	11	-	S	$V_{DS} = 5V, I_{D} = 12A$	
Diode Forward Voltage	V_{SD}	-	0.76	1.0	V	$V_{GS} = 0V$, $I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	-	945	-		V _{DS} = 20V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	-	69	-	pF		
Reverse Transfer Capacitance	C _{rss}	-	58	-		1 = 1.0WHZ	
Gate Resistance	R_g	-	1.45	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge V _{GS} = 4.5V	Qg	-	8.4	-		$V_{GS} = 4.5V, V_{DS} = 20V, I_D = 12A$	
Total Gate Charge V _{GS} = 10V	Qq	-	18.6	-	0		
Gate-Source Charge	Q _{qs}	-	3.3	-	nC	$V_{GS} = 10V, V_{DS} = 20V,$	
Gate-Drain Charge	Q _{qd}	-	2.2	-		$I_D = 12A$	
Turn-On Delay Time	t _{D(on)}	-	6.4	-	ns		
Turn-On Rise Time	t _r	-	9.7	-	ns	$V_{GS} = 10V, V_{DS} = 20V,$	
Turn-Off Delay Time	t _{D(off)}	-	19.8	-	ns	$R_L = 1.6\Omega$, $R_G = 3\Omega$	
Turn-Off Fall Time	t _f	-	3.1	-	ns		

Notes:

- 4. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
- 5. Device mounted on 2" x 2" FR-4 PCB with high coverage 2 oz. Copper, single sided.
- Repetitive rating, pulse width limited by junction temperature.
 Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.







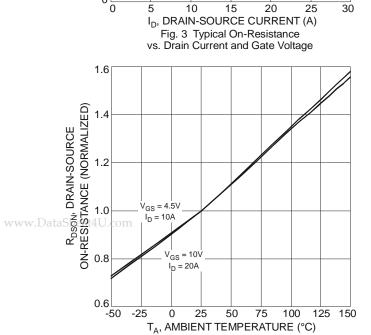
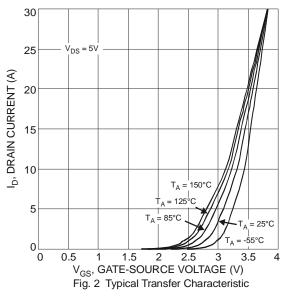
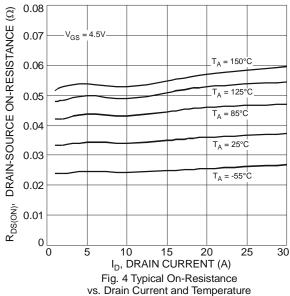


Fig. 5 On-Resistance Variation with Temperature





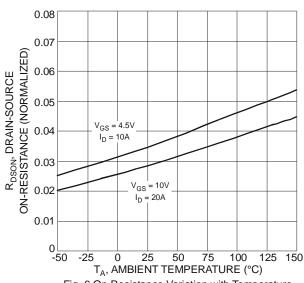


Fig. 6 On-Resistance Variation with Temperature

0.01

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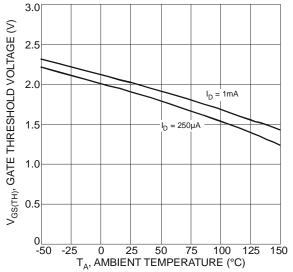
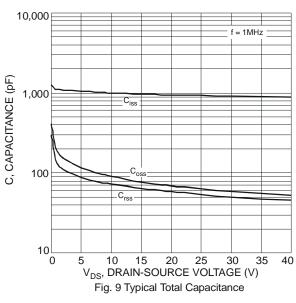
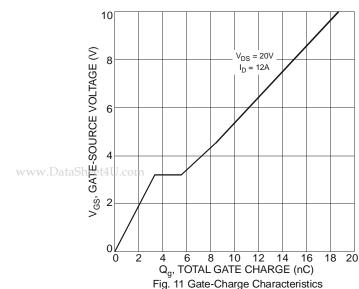
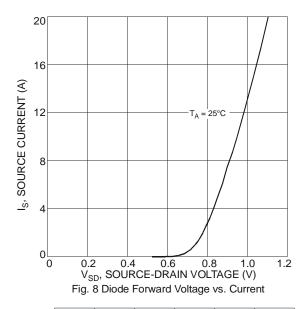
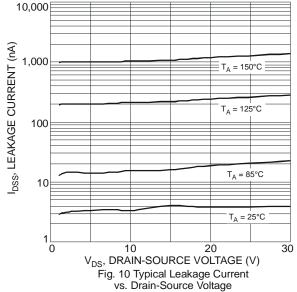


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

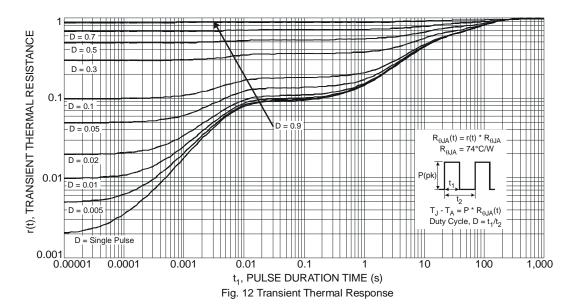




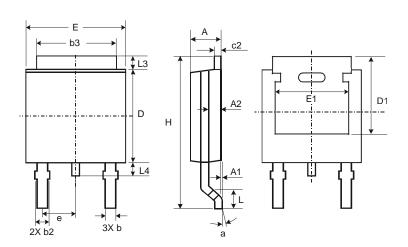








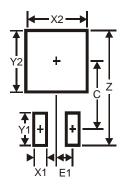
Package Outline Dimensions



TO252-3L					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
c2	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	_	_		
е	_	_	2.286		
Е	6.45	6.70	6.58		
E1	4.32	_	_		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	_		
All Dimensions in mm					

Suggested Pad Layout

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Dimensions	Value (in mm)		
Z	11.6		
X1	1.5		
X2	7.0		
Y1	2.5		
Y2	7.0		
С	6.9		
E1	2.3		

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